L Number	Hits	Search Text	DB	Time stamp
1	1061	425/135.ccls.	USPAT;	2004/01/05 15:17
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	164	73/856.ccls.	USPAT	2004/01/02 15:17
-	10	73/856.ccls. and mold	USPAT	2001/02/26 09:38
-	5	73/856.ccls. and (mold molding) and (injection inject pressure)	USPAT	2001/02/26 09:36
-	40553	(injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/02/26 09:42
		machine).clm.	ЕРО; ЛРО;	
		,	DERWENT,	
			IBM TDB	
_	9162	(injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/02/26 15:12
		machine) and (control controls).clm.	EPO; JPO;	
ļ		madrine) and (bond of bond of	DERWENT;	I
			IBM_TDB	•
_	21	((injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/07/24 13:34
- ,	21	machine) and (control controls) and sensor and switch).clm.	EPO; JPO;	2001/07/24 15.54
:		inactifie) and (control controls) and sensor and switch).cmi.		
			DERWENT;	
	4	//initedian	IBM_TDB	2001/02/26 16:00
-	4	((injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/02/26 10:00
		machine) and (control controls) and (force pressure strain) near4 sensor	EPO; JPO;	:
		and switch).clm.	DERWENT;	
			IBM_TDB	.
-	10	(injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/02/27 13:41
		machine) and (control controls)and (subtractor substractor).clm.	ЕРО, ЛО,	
			DERWENT;	
			IBM_TDB	
-	2	((injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/02/27 13:45
		machine) and (control controls)and (subtractor substractor)and (clamp	ЕРО, ЛРО;	
		clamping)).clm.	DERWENT,	
			IBM_TDB	
-	1	((injection pressure) and (molding mold) and (device apparatus	USPAT,	2001/02/27 13:45
l		machine) and (control controls)and (subtractor substractor)and (clamp	ЕРО; ЛРО;	
		clamping)and sensor).clm.	DERWENT;	
			IBM_TDB	
-!	26	("4131596" "4506321" "4714867" "5274316" "5313151" "5341452"	USPĀT;	2001/07/23 17:05
:		"5362222" "5444341" "5583411").pn.	EPO; JPO;	:
		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	DERWENT;	
			IBM_TDB	
_	27	("3864557" "3870445" "3878372" "3937776" "4094940" "4311446"	USPAT;	2001/07/23 17:06
	2,	"5232714" "5237509").pn.	EPO; JPO;	:
		5252.1. 5251507 j.pn.	DERWENT;	
			IBM_TDB	
_	1	((injection pressure) and (molding mold) and (device apparatus	USPAT;	2001/07/24 14:01
	1	machine) and (control controls) and force near2 sensor and switch).clm.	EPO; JPO;	2001101124 14.01
		machine, and (conduct conducts) and force near 2 sensor and switch J.C.III.	DERWENT;	
		<u> </u>		
_	1	((injection pressure) near2 (molding mold) near2 (device apparatus	IBM_TDB	2001/07/24 14:41
-	1		USPAT;	2001/07/24 14:41
		machine) and (control controls) and force near2 sensor).clm.	ЕРО; ЛРО;	
;			DERWENT;	
	•	((initiation number 2 / 11/2 11) 2 / 2 / 1	IBM_TDB	0001/07/01/01
-	1	((injection pressure) near2 (molding mold) near2 (device apparatus	USPAT;	2001/07/24 14:06
ŀ		machine) and (control controls controller) and force near2 sensor).clm.	ЕРО; ЛРО;	
			DERWENT,	
			IBM_TDB	
-	17	425/\$6.ccls. and ((injection pressure) near2 (molding mold) near2	USPAT;	2002/01/25 16:32
		(device apparatus machine) and (control controls) and force near2	ЕРО; ЛРО;	
		sensor)	DERWENT;	
			IBM_TDB	1

1

-	10	425/\$6.ccls. and ((injection pressure) near2 (molding mold) near2	USPAT;	2001/07/24 14:49
	}	(device apparatus machine) and (control controls) and force near sensor)	EPO; JPO;	
	!		DERWENT;	i
i			IBM TDB	
_	. ! 1 Ì	425/\$6.ccls. and ((injection pressure) near2 (molding mold) near2	USPAT;	2001/07/24 14:53
:		(device apparatus machine) and (control controls) and force near sensor)	ЕРО; ЛРО;	2 001/07/24 14.55
İ				
	:	and platen	DERWENT;	
1	į l		IBM_TDB	
-	0 ;	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:56
	ì	(control controls) and ((force near sensor) near4 platen))	ЕРО; ЛРО;	
•	l i	i	DERWENT,	
	'		IBM_TDB	
_	. 0 .	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:56
	' i			!
Ì	i	(control controls) and ((force near sensor) near6 platen))	ЕРО; ЛРО;	ļ :
			DERWENT;	
			IBM_TDB	I
ļ -	i 1	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:57
		(control controls) and ((force near sensor) and platen))	EPO, JPO,	
			DERWENT;	
	1		IBM_TDB	
1		435/96 colo and ((injection management) money (molding mold) and		2001/07/24 14:50
: -	, 0	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:58
		(clamp\$4) near2 ((force near sensor) and platen))	ЕРО; ЛРО;	į.
İ	i		DERWENT;	
	1		IBM_TDB	
-	. 1	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:58
ſ	i	(clamp\$4) and ((force near sensor) and platen))	ЕРО; ЛРО;	
		(compos) and (cores near semest) and platen))	DERWENT;	
1				
i			IBM_TDB	
· -	0	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT;	2001/07/24 14:59
İ		(clamp\$4) near6 ((force near sensor) and platen))	ЕРО; ЛРО;	
			DERWENT;	
			IBM TDB	
ĺ <u>.</u>	88	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPĀT;	2001/07/24 14:59
1	00	(clamp\$4) near6 force and sensor and platen)	ЕРО; ЛРО;	!
	i	(clamps+) heard force and sensor and placen)	DERWENT;	i
!		105/05 1 17/2 1	' IBM_TDB	2001/05/24 15 05
-	4	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPAT,	2001/07/24 15:06
1		(clamp\$4) near6 force near4 sensor and platen)	ЕРО; ЛРО;	
			DERWENT;	
İ	:	! 	IBM_TDB	1
-	4	425/\$6.ccls. and ((injection pressure) near2 (molding mold) and	USPĀT;	2001/07/25 13:17
ļ	·	(clamp\$4 near6 force) and (force near4 sensor) and platen)	ЕРО; ЛРО;	!
	ì	(comp)	DERWENT;	•
				į
!	10	/#2070 A ASIL #5271 ASON #5012025# #532222# #4121503#\	IBM_TDB	2001/05/25 12 55
-	19	("3870445" "5371450" "5912025" "5632222" "4131596") .pn.	USPAT;	2001/07/25 13:27
1			ЕРО; ЛРО;	
			DERWENT;	
i			IBM_TDB	!
-	19	("3870445" "5371450" "5912025" "5362222" "4131596") .pn.	USPAT;	2001/07/25 13:28
ł		(ЕРО; ЛРО;	2001/07/25 15:20
	j		DERWENT;	
!				İ
		773/0561-	IBM_TDB	2002/07/27
. -		73/856.ccls.	USPAT	2002/01/25 16:32
· -	615	425/144.ccls.	USPAT;	2004/01/02 15:17
į			ЕРО; ЈРО;	
	1	l	DERWENT;	!
	•		IBM_TDB	i
-	699	318/560.ccls.	USPAT;	2004/01/02 15:18
			EPO; JPO;	1
!			·	
			DERWENT;	
<u></u>		<u></u>	IBM_TDB	L

-	2	318/560.ccls. and (mold near clamp\$5)	USPAT;	2002/01/25 16:34
			ЕРО; ЛРО;	
			DERWENT;	
	!		IBM_TDB	
-	187	73/856.ccls.	USPAT	2004/01/02 15:17
; -	644	425/144.ccls.	USPAT;	2004/01/05 15:17
İ	i		ЕРО; ЛРО;	
	1		DERWENT;	
	,		IBM_TDB	'
-	818	318/560.ccls.	USPAT;	2004/01/02 15:19
ŀ			EPO; JPO,	'
			DERWENT,	
1			IBM TDB	
: -	809	! ((position displac\$6 mov\$5 distance separation) near4 (sens\$4 detect\$4	USPĀT;	2004/01/02 15:43
:	i	transduc\$4 meter\$4) near4 (clamp platen plate)) and ((force pressure)	ЕРО; ЛРО;	
		near4 (sens\$4 detect\$4 transduc\$4 meter\$4) near4 (clamp platen plate))	DERWENT;	
	ł	and (processor cpu computer calculat\$4 control\$4)	IBM TDB	;
-	10	(((position displac\$6 mov\$5 distance separation) near4 (sens\$4 detect\$4	USPAT;	2004/01/02 15:38
	:	transduc\$4 meter\$4) near4 (clamp platen plate)) and ((force pressure)	ЕРО; ЈРО;	i i
	İ	near4 (sens\$4 detect\$4 transduc\$4 meter\$4) near4 (clamp platen plate))	DERWENT;	
		and (processor cpu computer calculat\$4 control\$4)) and (mold\$4 near4	IBM TDB	
		(clamp\$4 grip\$4 bind\$4) near6 motor)		
i -	189		USPAT;	2004/01/02 15:39
		transduc\$4 meter\$4) near4 (clamp platen plate)) and ((force pressure)	EPO; JPO;	200 1/01/02 15:55
		near4 (sens\$4 detect\$4 transduc\$4 meter\$4) near4 (clamp platen plate)	DERWENT;	
i		and (processor cpu computer calculat\$4 control\$4)) and (73/\$6.ccls.	IBM TDB	
	·	425/\$6.ccls. 318/\$6.ccls.)	15.41_155	
-	: 40	(((position displac\$6 mov\$5 distance separation) near4 (sens\$4 detect\$4	USPAT;	2004/01/02 16:52
•		transduc\$4 meter\$4) near4 (clamp platen plate)) and ((force pressure)	EPO; JPO;	100 1101102 10.52
		near4 (sens\$4 detect\$4 transduc\$4 meter\$4) near4 (clamp platen plate)	DERWENT;	
		and (processor cpu computer calculat\$4 control\$4)) and ((mov\$4	IBM TDB	
:		displac\$4) near4 (plate? clamp\$4 mold\$4)) and ((stationary static		
i	\	non?mov\$4 immobil\$4) near4 (plate? clamp\$4 mold\$4))		
_	2	the state of the s	USPAT;	2004/01/02 16:52
		- 1022001.pii. 	EPO; JPO;	2007/01/02 10.32
	i		DERWENT;	
			BM TDB	' I
L		<u> </u>	mini_i DD	j